

PRODUCT RELIABILITY REPORT FOR

DS28E01, Rev B2

Dallas Semiconductor

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Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products:

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport/dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

```
AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts
AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10-5 eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
Ea = Activation Energy (e.g. 0.7 ev)
```

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

```
AfV = exp(B*(Vs - Vu))

AfV = Acceleration factor due to Voltage

Vs = Stress Voltage (e.g. 7.0 volts)

Vu = Maximum Operating Voltage (e.g. 5.5 volts)

B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)
```

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

```
Fr = X/(ts * AfV * AfT * N * 2)
X = Chi-Sq statistical upper limit
N = Life test sample size
```

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 80914 FITS: 1.4

DEVICE HOURS: 688608 FAILS: 0

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 5.5 Volts

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. "*" after DATE CODE denotes specific product data.

Device Information:

Process: E35WN-

3P3M,DPE2,NTC,DSD,PDESD,PDRES,Cap,ENPN,DPT,HTO,SgHalo

Passivation: TEOS Ox-Nit 2-Mask Laser/Pass for E35WM; Full BEOL at

X3; PT only in Dallas

Die Size: 70 x 79 Number of Transistors: 7674

Interconnect: Aluminum / 1% Silicon / 0.5% Copper

Gate Oxide Thickness: 120 Å

ELECTRICAL CHARACTERIZATION

DESCRIPTION	DATE CODE CONDITION			READPOINT		FAILS	FA#
ESD SENSITIVITY	0629 *	EOS/ESD S5.1 HBM 2000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0629 *	EOS/ESD S5.1 HBM 4000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0629 *	EOS/ESD S5.1 HBM 8000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0629 *	IEC 61000-4-2 CONTACT 2000 VOLTS	10	PUL'S	3	0	
ESD SENSITIVITY	0629 *	IEC 61000-4-2 CONTACT 4000 VOLTS	10	PUL'S	3	0	
ESD SENSITIVITY	0629 *	IEC 61000-4-2 CONTACT 8000 VOLTS	10	PUL'S	3	0	
ESD SENSITIVITY	0629 *	IEC 61000-4-2 AIR 2000 VOLTS	10	PUL'S	3	0	
ESD SENSITIVITY	0629 *	IEC 61000-4-2 AIR 4000 VOLTS	10	PUL'S	3	0	
ESD SENSITIVITY	0629 *	IEC 61000-4-2 AIR 8000 VOLTS	10	PUL'S	3	0	
ESD SENSITIVITY	0629 *	IEC 61000-4-2 AIR 15000 VOLTS	10	PUL'S	3	0	
LATCH-UP	0629 *	JESD78, V-SUPPLY TEST 125C			6	0	
				Total:		0	

DESCRIPTION	DATE CODE CONDITION		READPOINT	QTY FAILS	FA#
HIGH TEMP OP LIFE	0602	125C 5.5 \/ (PSA) & 0.0 \/ (PSR)	1000 HRS	77 O	

HIGH TEMP OP LIFE	0604	125C, 5.5 VOLTS	1000	HRS	77	0	
HIGH TEMP OP LIFE	0620	125C, 5.25 VOLTS	1000	HRS	77	0	
HIGH TEMP OP LIFE	0622	125C, 5.25 VOLTS	1000	HRS	77	0	
HIGH TEMP OP LIFE	0624	125C, 5.5 VOLTS	192	HRS	72	0	
HIGH TEMP OP LIFE	0624	125C, 5.25 VOLTS	1000	HRS	45	0	
HIGH TEMP OP LIFE	0627	125C, 5.25 VOLTS	1000	HRS	77	0	
HIGH TEMP OP LIFE	0629	125C, 3.5 VOLTS	1000	HRS	77	0	
HIGH TEMP OP LIFE	0629	125C, 5.25 VOLTS	1000	HRS	76	0	
HIGH TEMP OP LIFE	0629 *	125C, 5.25 VOLTS	1000	HRS	77	0	
HIGH TEMP OP LIFE	0642	125C, 5.5 VOLTS	192	HRS	77	0	
				Total:		0	
W/E ENDURANCE A	ND DATA F	RET'N					
DESCRIPTION	DATE COL	DE CONDITION	REAL	DPOINT	QTY	FAILS	FA#
WRITE CYCLE STRESS (KCYS)	0538	85 C, 5.5 VOLTS	5	KCYS	77	0	
		50 C, 5.5 VOLTS	25	KCYS	77	0	
STORAGE LIFE		150C	96	HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0538	85 C, 5.5 VOLTS	5	KCYS	77	0	
		50 C, 5.5 VOLTS	25	KCYS	77	0	
STORAGE LIFE		150C	96	HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0538	85 C, 5.5 VOLTS	5	KCYS	77	0	
		50 C, 5.5 VOLTS	25	KCYS	77	0	
STORAGE LIFE		150C	96	HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0538	50 C, 5.5 VOLTS	25	KCYS	77	0	
STORAGE LIFE		150C	96	HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0538	50 C, 5.5 VOLTS	25	KCYS	77	0	
STORAGE LIFE		150C	96	HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0538	50 C, 5.5 VOLTS	25	KCYS	77	0	
STORAGE LIFE		150C	96	HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0538	50 C, 5.5 VOLTS	25	KCYS	77	0	
STORAGE LIFE		150C	96	HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0538	50 C, 5.5 VOLTS	25	KCYS	77	0	
STORAGE LIFE		150C	96	HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0538	50 C, 5.5 VOLTS	25	KCYS	77	0	
STORAGE LIFE		150C	96	HRS	76	0	
WRITE CYCLE STRESS (KCYS)	0538	50 C, 5.5 VOLTS	25	KCYS	77	0	

FAII LIDE DATE:	МТ	TE (VPS).	2001 <i>/</i>	FITS:	ļ	1 /1		٠
STORAGE LIFE		150C				HRS Fotal:	77	0 0
WRITE CYCLE STRESS (KCYS)	0642	70 C, 5.5 VOLTS			30	KCYS	77	0
STRESS (KCYS) STORAGE LIFE	*	150C			1000	HRS	77	0
WRITE CYCLE	0629 *	85 C, 5.25 VOLTS			50	KCYS	77	0
STRESS (KCYS) STORAGE LIFE		150C			1000	HRS	76	0
WRITE CYCLE	0629	85 C, 5.25 VOLTS			50	KCYS	76	0
STRESS (KCYS) STORAGE LIFE		150C			1000	HRS	77	0
WRITE CYCLE	0629	25 C, 3.5 VOLTS			40	KCYS	77	0
STRESS (KCYS) STORAGE LIFE		150C			1000	HRS	77	0
WRITE CYCLE	0629	85 C, 3.5 VOLTS			10	KCYS	77	0
STRESS (KCYS) STORAGE LIFE		150C			1000	HRS	77	0
WRITE CYCLE	0627	85 C, 5.25 VOLTS			50	KCYS	77	0
STRESS (KCYS) STORAGE LIFE		150C			1000	HRS	72	0
WRITE CYCLE	0624	70 C, 5.5 VOLTS			50	KCYS	72	0
STRESS (KCYS) STORAGE LIFE		150C			1000	HRS	77	0
WRITE CYCLE	0622	85 C, 5.25 VOLTS			30	KCYS	77	0
STRESS (KCYS) STORAGE LIFE		150C			1000	HRS	77	0
WRITE CYCLE	0620	85 C, 5.25 VOLTS			50	KCYS	77	0
STRESS (KCYS) STORAGE LIFE		150C			1000	HRS	77	0
WRITE CYCLE	0604	85 C, 5.5 VOLTS			50	KCYS	77	0
STRESS (KCYS) STORAGE LIFE		150C			1000	HRS	77	0
WRITE CYCLE	0604	70 C, 5.5 VOLTS			30	KCYS	77	0
STRESS (KCYS) STORAGE LIFE		150C			1000	HRS	77	0
WRITE CYCLE	0602	85 C, 5.5 V (PSA) &	15.0 V (PSB)		1	KCYS	77	0
STRESS (KCYS) STORAGE LIFE		150C			96	HRS	77	0
WRITE CYCLE	0538	50 C, 5.5 VOLTS			25	KCYS	77	0
STRESS (KCYS) STORAGE LIFE	0000	150C			96	HRS	76	0
WRITE CYCLE	0538	50 C, 5.5 VOLTS			25	KCYS	77	0
STORAGE LIFE	0538	150C			96	HRS	77	0

FAILURE RATE: MTTF (YRS): 80914 FITS: 1.4

DEVICE HOURS: 688608 FAILS: 0